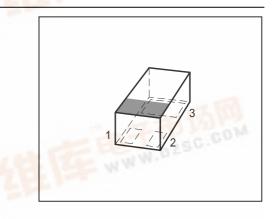
查询BFR193L3供应商



BFR193L3

NPN Silicon RF Transistor*

- For low noise, high-gain amplifiers up to 2 GHz
- For linear broadband amplifiers
- $f_{\rm T}$ = 8 GHz, F = 1 dB at 900 MHz
- * Short term description



ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Туре	Marking		Pin Configuration		Package	
BFR193L3	RC	1 = B	2 = E	3 = C	TSLP-3-1	
Maximum Ratings			100	E BI	DZSC.CU	
Parameter		. /	Symbol	Value	Unit	
Collector-emitter voltage			VCEO	12	V	
Collector-emitter voltage			V _{CES}	20		
Collector-base voltage			V _{CBO}	20		
Emitter-base voltage			V _{EBO}	2		
Collector current		I _C	80	mA		
Base current			/ _B 10		LBZSC.CO.	
Total power dissipation ¹⁾		P _{tot} 580		mW		
$T_{\rm S} \le 95^{\circ}{\rm C}$	130		NO ==			
Junction temperature			T _i	150		
Ambient temperature		T _A	-55 15	50		
Storage temperature			T _{stg}	-55 15	50	
Thermal Resistance				··1	市场四	
Parameter			Symbol	Value	Unit	
Junction - soldering point ²⁾			R _{thJS}	tbd	K/W	

 $^{1}T_{S}$ is measured on the collector lead at the soldering point to the pcb

²For calculation of R_{thJA} please refer to Application Note Thermal Resistance





Parameter	Symbol		Values		Unit
		min.	typ.	max.	1
DC Characteristics					•
Collector-emitter breakdown voltage	V _{(BR)CEO}	12	-	-	V
$I_{\rm C} = 1 {\rm mA}, I_{\rm B} = 0$					
Collector-emitter cutoff current	I _{CES}	-	-	100	μA
$V_{CE} = 20 \text{ V}, V_{BE} = 0$					
Collector-base cutoff current	I _{CBO}	-	-	100	nA
$V_{\rm CB} = 10 \text{ V}, I_{\rm E} = 0$					
Emitter-base cutoff current	I _{EBO}	-	-	1	μA
$V_{\rm EB} = 1 \text{V}, I_{\rm C} = 0$					
DC current gain-	h _{FE}	70	100	140	-
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, pulse measured					

Electrical Characteristics at $T_A = 25^{\circ}$ C, unless otherwise specified



BFR193L3

Electrical Characteristics at $T_A = 25^{\circ}$ C, unles Parameter	Symbol		Values		
			typ.	max.	Unit
AC Characteristics (verified by random sampli	ng)	l 	l 		
Transition frequency	f _T	6	8	-	GHz
$I_{\rm C} = 50 \text{ mA}, V_{\rm CE} = 8 \text{ V}, f = 500 \text{ MHz}$					
Collector-base capacitance	C _{cb}	-	0.63	0.9	pF
$V_{CB} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$,					
emitter grounded					
Collector emitter capacitance	C _{ce}	-	0.22	-]
$V_{CE} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$,					
base grounded					
Emitter-base capacitance	C _{eb}	-	2.25	-	
$V_{\text{EB}} = 0.5 \text{ V}, f = 1 \text{ MHz}, V_{\text{CB}} = 0$,					
collector grounded					
Noise figure	F				dB
$I_{\rm C} = 10 \text{ mA}, V_{\rm CE} = 8 \text{ V}, Z_{\rm S} = Z_{\rm Sopt},$					
<i>f</i> = 900 MHz		-	1	-	
$I_{\rm C}$ = 10 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,					
<i>f</i> = 1.8 GHz		-	1.6	-	
Power gain, maximum available ¹⁾	G _{ma}				
$I_{\rm C} = 30 \text{ mA}, V_{\rm CE} = 8 \text{ V}, Z_{\rm S} = Z_{\rm Sopt}$,					
$Z_{\rm L} = Z_{\rm Lopt}$, $f = 900 \text{ MHz}$		-	19	-	
$I_{\rm C} = 30 \text{ mA}, V_{\rm CE} = 8 \text{ V}, Z_{\rm S} = Z_{\rm Sopt}$,					
$Z_{\rm L} = Z_{\rm Lopt}$, $f = 1.8 \rm GHz$		-	12.5	-	
Transducer gain	S _{21e} ²				dB
$I_{\rm C} = 30 \text{ mA}, V_{\rm CE} = 8 \text{ V}, Z_{\rm S} = Z_{\rm L} = 50 \Omega$,					
<i>f</i> = 900 MHz		-	14.5	-	
$I_{\rm C} = 30 \text{ mA}, \ V_{\rm CE} = 8 \text{ V}, \ Z_{\rm S} = Z_{\rm L} = 50 \Omega$,					
<i>f</i> = 1.8 GHz		-	9	-	

 ${}^{1}G_{ma} = |S_{21} / S_{12}| (k - (k^{2} - 1)^{1/2})$

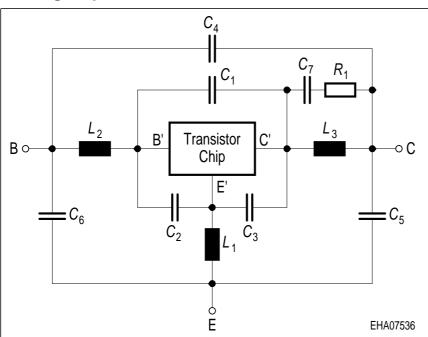


SPICE Parameter (Gummel-Poon Model, Berkley-SPICE 2G.6 Syntax):

Transitor Chip Data:

IS =	0.2738	fA	BF =	125	-	NF =	0.95341	-
VAF =	24	V	IKF =	0.26949	А	ISE =	10.627	fA
NE =	1.935	-	BR =	14.267	-	NR =	1.4289	-
VAR =	3.8742	V	IKR =	0.037925	А	ISC =	0.037409	fA
NC =	0.94371	-	RB =	1.8368	Ω	IRB =	0.91763	mA
RBM =	1	Ω	RE =	0.76534	-	RC =	0.11938	Ω
CJE =	1.1824	fF	VJE =	0.70276	V	MJE =	0.48654	-
TF =	18.828	ps	XTF =	0.69477	-	VTF =	0.8	V
ITF =	0.96893	mA	PTF =	0	deg	CJC =	935.03	fF
VJC =	1.1828	V	MJC =	0.30002	-	XCJC =	0.053563	-
TR =	1.0037	ns	CJS =	0	fF	VJS =	0.75	V
MJS =	0	-	NK =	0	-	EG =	1.11	eV
XTI =	3	-	FC =	0.72063		TNOM	300	K

All parameters are ready to use, no scalling is necessary. Extracted on behalf of Infineon Technologies AG by: Institut für Mobil- und Satellitentechnik (IMST)



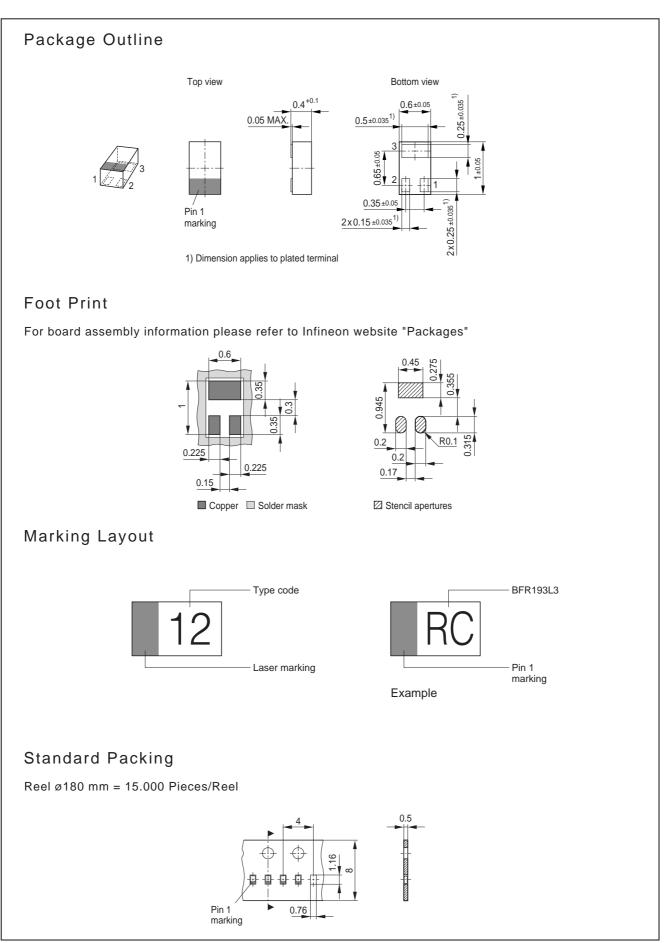
Package Equivalent Circuit:

L ₁ =	0.575	nH
$L_{2} =$	0.575	nH
$L_3 =$	0.275	nH
$C_{1} =$	33	fF
$C_{2} =$	28	fF
$C_{3} =$	131	fF
$C_4 =$	8	fF
$C_5 =$	8	fF
$C_6 =$	24	fF
С ₇ =	300	fF
R ₁ =	204	Ω

Valid up to 6GHz

For examples and ready to use parameters please contact your local Infineon Technologies distributor or sales office to obtain a Infineon Technologies CD-ROM or see Internet: http://www.infineon.com/silicondiscretes







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